

**AMENDMENTS TO THE CLAIMS**

**This listing of claims will replace all prior versions and listings of claims in the application:**

**LISTING OF CLAIMS:**

1. (original): A method of supplying a substrate comprising the step of:  
supplying a substrate on which a chip is to be mounted to a chip mounting apparatus in the form of a discrete substrate or an independent unit substrate consisting of a plurality of discrete substrates.

**Claims 2-27 are canceled.**